



## **PRODUCT/PROCESS CHANGE NOTIFICATION**

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**PCN MMS-MMY/14/8411**

**Dated 26 Mar 2014**

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**AMKOR new and additional SO8N assembly & test line for  
CMOSF8H+ Industrial Range EEPROM**

**Table 1. Change Implementation Schedule**

Forecasted implementation date for change	19-Mar-2014
Forecasted availability date of samples for customer	16-May-2014
Forecasted date for <b>STMicroelectronics</b> change Qualification Plan results availability	16-May-2014
Estimated date of changed product first shipment	25-Jun-2014

**Table 2. Change Identification**

Product Identification (Product Family/Commercial Product)	EEPROM (industrial range) in SO8N / CMOSF8H+
Type of change	Assembly additional location
Reason for change	Second source creation
Description of the change	AMKOR subcontractor (Philippines) new assembly line for all EEPROM (industrial range) in SO8N / CMOSF8H+
Change Product Identification	First digit of date code is "B" when last is "T"
Manufacturing Location(s)	

## DOCUMENT APPROVAL

Name	Function
Leduc, Hubert	Marketing Manager
Rodrigues, Benoit	Product Manager
Pavano, Rita	Q.A. Manager



## PRODUCT / PROCESS CHANGE NOTIFICATION

### AMKOR new and additional SO8N assembly & test line for CMOSF8H+ Industrial Range EEPROM

#### What is the change?

The EEPROM products (industrial range) processed with CMOSF8H+ process technology at ST Rousset (France) and assembled/tested in SO8N package at ST Shenzhen (China) will be also assembled/tested on new AMKOR *extra high density lead frame* (XDLF) assembly line (also using 0.8 mil Copper bonding wire).

#### Why?

The strategy of STMicroelectronics Memory Division is to support our customers on a long-term basis. In line with this commitment, the qualification of the AMKOR new XDLF SO8N assembly line for the EEPROM products (industrial range) in CMOSF8H+ will increase the production capacity throughput and consequently improve the service to our customers.

#### When?

The production of the EEPROM (industrial range) in CMOSF8H+ on the new XDLF SO8N assembly line at AMKOR will ramp up from middle of May 2014 and shipments can start from middle of June 2014 onward (or earlier upon customer approval).

#### How will the change be qualified?

The EEPROM products (industrial range) in CMOSF8H+ assembled on the new XDLF SO8N assembly line at AMKOR will be qualified following the standard ST Microelectronics Corporate Procedures for Quality & Reliability.

**Qualification Plan QPMMY1304** is included inside this document.

#### What is the impact of the change?

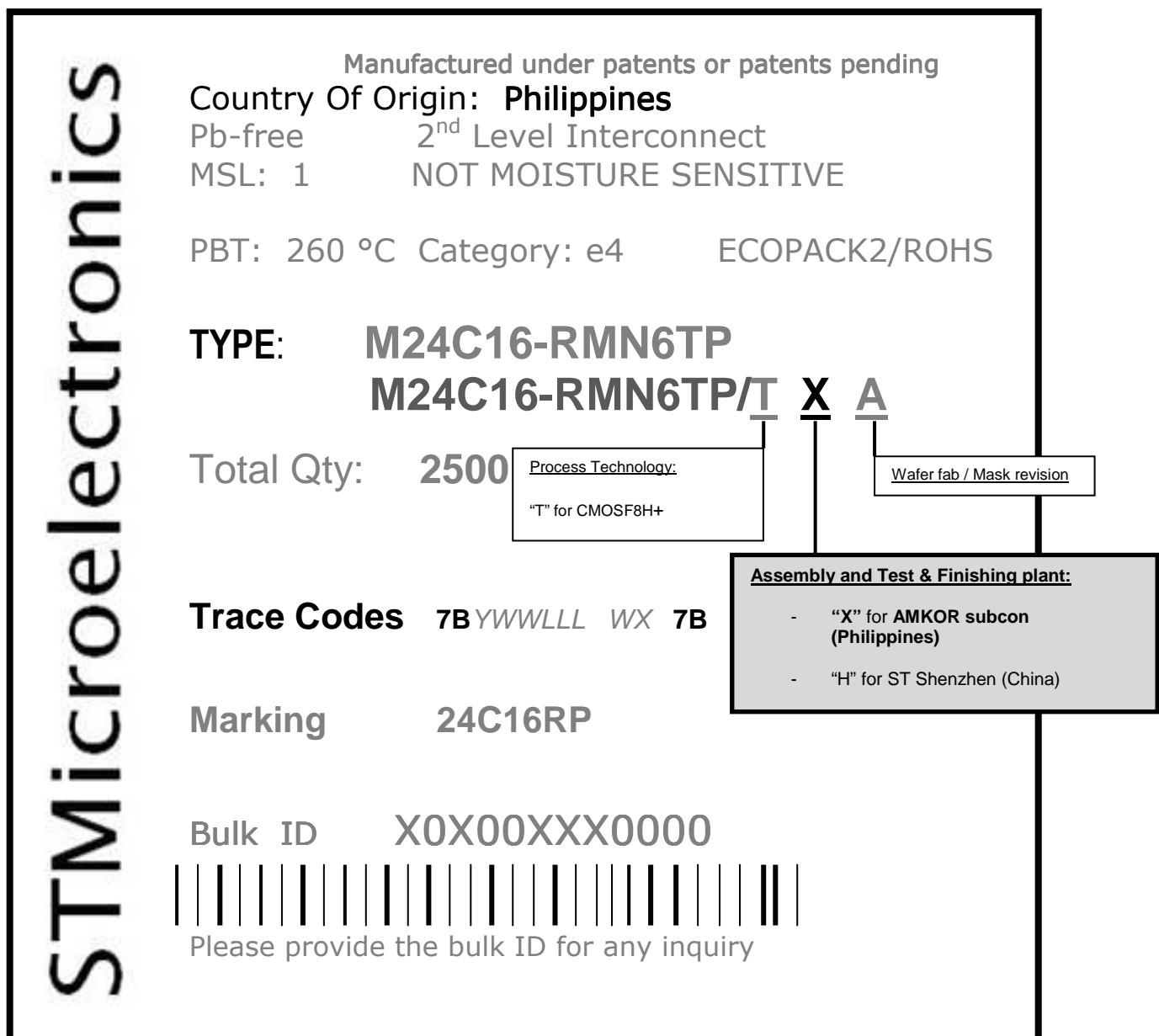
- **Form:** Marking change
- **Fit:** No change
- **Function:** No change

## How can the change be seen?

### - BOX LABEL MARKING

On the BOX LABEL MARKING, the difference is visible inside the **Finished Good Part Number** where the “**Assembly and Test & Finishing plants**” identifier is “**X**” for products assembled on XDLF line at **AMKOR**, this digit being “**H**” for current products assembled at ST Shenzhen. Also **Country of origin** will change from China to **Philippines**. In the **Trace code**, the identifiers for “**Assembly country & plant**” and “**Test & Finishing country & plant**” will change from “**GK**” to “**7B**”.

→ Example for M24C16-RMN6TP



## How can the change be seen?

### - SO8N DEVICE MARKING

The difference is visible inside the Trace Code *PYWWT* (\*) where the first digit *P* for *Assembly plant* is “**B**” for AMKOR, this digit being “**K**” for current ST Shenzhen assembly plant.



*(\*) Legend:*

*P* = Assembly plant  
*Y* = Assembly year  
*WW* = Assembly week  
*T* = Process technology

## Appendix A- Product Change Information

<b>Product family / Commercial products:</b>	EEPROM (industrial range) in SO8N / CMOSF8H+
<b>Customer(s):</b>	All
<b>Type of change:</b>	New assembly line
<b>Reason for the change:</b>	Second source creation
<b>Description of the change:</b>	AMKOR subcontractor (Philippines) new assembly line for all EEPROM (industrial range) in SO8N / CMOSF8H+
<b>Forecast date of the change: (Notification to customer)</b>	Week 12 / 2014
<b>Forecast date of <u>Qualification samples</u> availability for customer(s):</b>	See Appendix B
<b>Qualification Report availability:</b>	<b>Qualification Plan QPMMY1304</b> is included inside this document
<b>Marking to identify the changed product:</b>	First digit of date code is "B" when last is "T".
<b>Description of the qualification program:</b>	Standard ST Microelectronics Corporate Procedures for Quality and Reliability
<b>Product Line(s) and/or Part Number(s):</b>	See Appendix B
<b>Estimated date of first shipment:</b>	Week 26 / 2014

**Appendix B: Concerned Commercial Part Numbers:**

Commercial Part Numbers	Samples availability
M24C01-WMN6TP	Week 20 / 2014
M24C01-RMN6TP	Week 20 / 2014
M24C02-WMN6TP	Week 20 / 2014
M24C02-RMN6TP	Week 20 / 2014
M24C02-FMN6TP	Week 20 / 2014
M24C04-WMN6TP	Week 20 / 2014
M24C04-RMN6TP	Week 20 / 2014
M24C04-FMN6TP	Week 20 / 2014
M24C08-WMN6TP	Week 20 / 2014
M24C08-RMN6TP	Week 20 / 2014
M24C08-FMN6TP	Week 20 / 2014
M24C16-RMN6TP	Week 18 / 2014
M24C16-FMN6TP	Week 18 / 2014
M24C16-WMN6TP	Week 18 / 2014

## Appendix C: Qualification Plan:

Test	Method	Conditions	Sample size	Lots	Acceptance Criteria
<b>General</b>					
Bonding DOE				3 lots	No major concern
Construction analysis			30 parts	1 lot	No Major Concern
Assembly report				3 lots	No major concern
Test report				3 lots	Yield > 95%
POA			10 parts	1 lot	No major concern
<b>Reliability (note a)</b>					
TMCL	JESD22-A104	-65°C/+150°C	77	3 lots	A0R1 at 500 cycles
HTS	JESD22-A103	150°C	77	3 lots	A0R1 at 1000 hrs
THB	JESD22-A101	85°C/85%RH	77	3 lots	A0R1 at 1000 hrs
PPT	JESD22-A102	121°C, 2atm	77	3 lots	A0R1 at 96 hrs
TMSK	JESD22-A106	-55°C/+125°C	77	3 lots	A0R1 at 200 shocks

**Appendix D: BOM comparison:**

Material	New BOM at AMKOR	Current BOM at ST Shenzhen
<b>LEAD FRAME</b>	SO-8	SO-8
<b>MOLDING COMPOUND</b>	SUMITOMO G700	SUMITOMO G700
<b>COPPER WIRE</b>	0.8 mil (*)	0.8 mil (**)
<b>GLUE DIE ATTACH</b>	Ablestik 8290	Ablebond 8611

(\*) Palladium Coated Copper

(\*\*) Bare Copper

## Document Revision History

## Source Documents & Reference Documents

<b>Source document Title</b>	<b>Rev.:</b>	<b>Date:</b>



## Public Products List

PCN Title : AMKOR new and additional SO8N assembly & test line for CMOSF8H+ Industrial Range EEPROM

PCN Reference : MMS-MMY/14/8411

PCN Created on : 19-MAR-2014

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change:

### ST COMMERCIAL PRODUCT

M24C01-RMN6TP	M24C01-WMN6TP	M24C02-FMN6TP
M24C02-RMN6TP	M24C02-WMN6TP	M24C04-FMN6TP
M24C04-RMN6TP	M24C04-WMN6TP	M24C08-FMN6TP
M24C08-RMN6TP	M24C08-WMN6TP	M24C16-FMN6TP
M24C16-RMN6TP	M24C16-WMN6TP	

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